

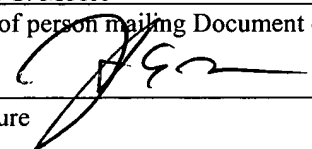
IFW

Mail Stop Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

I hereby certify that this correspondence is being deposited  
with the United States Postal Service with sufficient postage  
as first class mail in an envelope addressed to: Mail Stop  
Amendment, Commissioner for Patents, P.O. Box 1450,  
Alexandria, VA 22313-1450 on February 28, 2005  
(Date of Deposit)

Harold C. Moore

Name of person mailing Document or Fee

  
Signature

February 28, 2005

Date of Signature

Re:            Application of:        Tilke et al.  
              Serial No.:        10/780,276  
              Filed:            February 17, 2004  
              For:              Semiconductor Structure with Increased  
                                     Breakdown Voltage and Method for  
                                     Producing the Semiconductor Structure  
              Group Art Unit:    2811  
              Examiner:        Thien F. Tran  
              Our Docket No.:    1890-0061

### TRANSMITTAL

Please find for filing in connection with the above patent application the  
following:

1.     Response to Restriction Requirement; and
2.     One (1) return post card.

\* The fee has been calculated as shown below.

CLAIMS AS AMENDED				
	Claims Remaining After Amendment	Highest No. Paid For	Fee Calculation	Addit Fee
Total Claims	16	20	0 X 18	\$ 0.00
Independent Claims	2	3	0 X 84	\$ 0.00
Total Additional Fee Required				\$ 0.00

Please charge any fee deficiency, or credit any overpayment, to Deposit Account No. 13-0014; but not to include any payment of issue fees.

Respectfully Submitted,

MAGINOT, MOORE & BECK



February 28, 2005

Harold C. Moore  
Registration No. 37,892  
Bank One Center/Tower  
111 Monument Circle, Suite 3000  
Indianapolis, Indiana 46204-5115

Enclosures



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Mail Stop Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

I hereby certify that this correspondence is being  
deposited with the United States Postal Service as  
first class mail in an envelope addressed to:  
Mail Stop Amendment, Commissioner for Patents,  
P.O. Box 1450, Alexandria, VA 22313-1450 on  
February 28, 2005  
(Date of Deposit)

Harold C. Moore

Name of person mailing document or Fee

Signature

February 28, 2005

Date of Signature

Re:	Application of:	Tilke et al.
	Serial No.:	10/780,276
	Filed:	February 17, 2004
	For:	Semiconductor Structure with Increased Breakdown Voltage and Method for Producing the Semiconductor Structure
	Group Art Unit:	2811
	Confirmation No.:	7063
	Examiner:	Thien F. Tran
	Our Docket No.:	1890-0061

RESPONSE TO OFFICE ACTION

Sir:

In response to the Office Action dated January 27, 2005 for the above-identified  
patent application, please amend the application as follows:

Amendments to the claims begin on page 2 of the paper.